

### IRSM505-055 IRSM515-055 Series

# 1.7Ω, 500V

## Integrated Power Module for Small Appliance Motor Drive Applications

#### Description

IRSM505-055 and IRSM515-055 are 3-phase Integrated Power Modules (IPM) designed for advanced appliance motor drive applications such as energy efficient fans and pumps. These advanced IPMs offers a combination of low R<sub>DS(on)</sub> Trench FREDFET technology and the industry benchmark half-bridge high voltage, rugged driver in a familiar package. The modules are optimized for low EMI characteristics.

IRSM505-055 includes temperature feedback while IRSM515-055 does not.

#### Features

- 500V 3-phase inverter including high voltage gate drivers
- Integrated bootstrap functionality
- Low 1.7Ω (max, 25°C) R<sub>DS(on)</sub> Trench FREDFET
- Under-voltage lockout for all channels
- Matched propagation delay for all channels
- Temperature feedback via NTC (IRSM505-055 only)
- Optimized dV/dt for loss and EMI trade offs
- Open-source for single and leg-shunt current sensing
- 3.3V logic compatible & advanced input filter
- Driver tolerant to negative transient voltage (-Vs)
- Isolation 1900V<sub>RMS</sub>, 1min
- RoHS Compliant
- Certified by UL File Number E252584



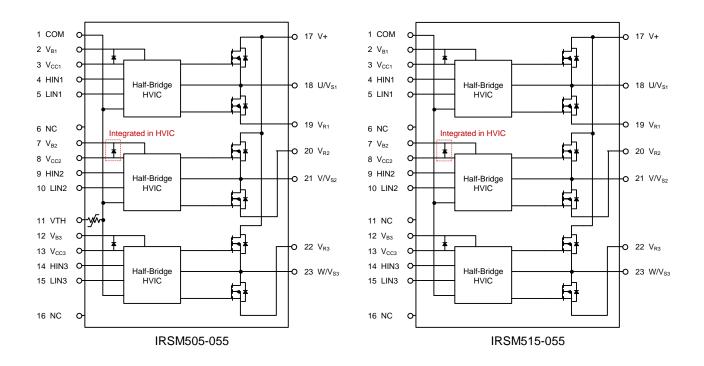


Series	NTC	Package Type	Standard Pac	k	Product Name
			Form	Quantity	
IRSM505-055	Yes	SOP23	Tube	240	IRSM505-055PA
		DIP23	Tube	240	IRSM505-055DA
		DIP23A	Tube	240	IRSM505-055DA2
IRSM515-055	No	SOP23	Tube	240	IRSM515-055PA
		DIP23	Tube	240	IRSM515-055DA
		DIP23A	Tube	240	IRSM515-055DA2

1



#### **Internal Electrical Schematic**



#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the module may occur. These are not tested at manufacturing. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table.

Symbol	Description	Min	Мах	Unit
BV <sub>DSS</sub>	MOSFET Blocking Voltage		500	V
Io @ Tc=25°C	DC Output Current per MOSFET		2.4	•
Iop @ Tc =25°С	Pulsed Output Current per MOSFET (Note 1)		15	A
P <sub>d</sub> @ T <sub>C</sub> =25°C	Maximum Power Dissipation per MOSFET		18	W
V <sub>ISO</sub>	Isolation Voltage (1min)		1900	V <sub>RMS</sub>
TJ	Operating Junction Temperature	-40	150	°C
Tc	Operating Case Temperature	-40	150	°C
Ts	Storage Temperature	-40	150	°C
V <sub>S1,2,3</sub>	High Side Floating Supply Offset Voltage	V <sub>B1,2,3</sub> - 20	V <sub>B1,2,3</sub> +0.3	V
V <sub>B1,2,3</sub>	High Side Floating Supply Voltage	-0.3	525	V
V <sub>CC</sub>	Low Side and Logic Supply voltage	-0.3	25	V
V <sub>IN</sub>	Input Voltage of LIN, HIN	COM -0.3	Vcc+0.3	V

Note 1: Pulse Width = 100µs, Single Pulse



#### **Recommended Operating Conditions**

Symbol	Symbol Description		Max	Unit
V+	Positive DC Bus Input Voltage		400	V
V <sub>S1,2,3</sub>	High Side Floating Supply Offset Voltage	(Note 2)	400	V
V <sub>B1,2,3</sub>	High Side Floating Supply Voltage	Vs+12	Vs+20	V
Vcc	Low Side and Logic Supply Voltage	13.5	16.5	V
V <sub>IN</sub>	Input Voltage of LIN, HIN, ITRIP, EN, FLT	0	5	V
Fp	PWM Carrier Frequency		20	kHz

Note 2: Logic operational for Vs from COM-8V to COM+500V. Logic state held for Vs from COM-8V to COM-VBS.

#### **Static Electrical Characteristics**

 $(V_{CC}-COM) = (V_B-V_S) = 15 \text{ V}.$  T<sub>C</sub> = 25°C unless otherwise specified. The V<sub>IN</sub> and I<sub>IN</sub> parameters are referenced to COM and are applicable to all six channels. The V<sub>CC<sub>UV</sub></sub> parameters are referenced to COM. The V<sub>BS<sub>UV</sub></sub> parameters are referenced to V<sub>S</sub>.

Symbol	Description	Min	Тур	Мах	Units	Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	500			V	T」=25°С, I∟к=250µА
I <sub>LKH</sub>	Leakage Current of High Side FET		12		μA	Tj=25°C, Vds=500V
I <sub>LKL</sub>	Leakage Current of Low Side FET Plus Gate Drive IC		14		μA	T <sub>J</sub> =25°C, V <sub>DS</sub> =500V
			1.3	1.7	Ω	TJ=25°C, Vcc=15V, Id = 1.2A
R <sub>DS</sub> (on)	Drain to Source ON Resistance		3.2		Ω	T <sub>J</sub> =150°C, V <sub>CC</sub> =15V, Id = 1A (Note 3)
Vsd	Mosfet Body Diode Forward Voltage		0.8		V	TJ=25°C, Vcc=15V, ID=1.2A
V <sub>IN,th+</sub>	Positive Going Input Threshold	2.2			V	
V <sub>IN,th</sub> -	Negative Going Input Threshold			0.8	V	
Vccuv+, Vbsuv+	$V_{CC}$ and $V_{BS}$ Supply Under-Voltage, Positive Going Threshold	8	8.9	9.8	V	
Vccuv-, Vbsuv-	$V_{CC}$ and $V_{BS}$ supply Under-Voltage, Negative Going Threshold	6.9	7.7	8.5	V	
Vссиvн, Vвѕиvн	V <sub>CC</sub> and V <sub>BS</sub> Supply Under-Voltage Lock-Out Hysteresis		1.2		V	
IQBS	Quiescent V <sub>BS</sub> Supply Current V <sub>IN</sub> =0V		45	60	μA	
IQBS, ON	Quiescent V <sub>BS</sub> Supply Current V <sub>IN</sub> =4V		45	60	μA	
locc	Quiescent V <sub>CC</sub> Supply Current V <sub>IN</sub> =0V		1.8	4	mA	
IQCC, ON	Quiescent V <sub>CC</sub> Supply Current V <sub>IN</sub> =4V		1.9	4	mA	
I <sub>IN+</sub>	Input Bias Current V <sub>IN</sub> =4V		5.7	18	μA	V <sub>IN</sub> =3.3V
I <sub>IN-</sub>	Input Bias Current VIN=0V			2	μA	V <sub>IN</sub> =0V
R <sub>BR</sub>	Internal Bootstrap Equivalent Resistor Value		250		Ω	Tj=25°C

Note 3: Characterized, not tested at manufacturing



#### **Dynamic Electrical Characteristics**

(V\_{CC}\text{-COM}) = (V\_{B}\text{-}V\_{S}) = 15 V.  $T_{C} = 25^{\circ}C$  unless otherwise specified.

Symbol	Description	Min	Тур	Max	Units	Conditions	
Ton	Input to Output Propagation Turn-On Delay Time		0.8	1.5	µs I₀=120mA, V+=30V		
T <sub>OFF</sub>	Input to Output Propagation Turn-Off Delay Time		0.9	1.5	μs	See Fig.1	
T <sub>FIL,IN</sub>	Input Filter Time (HIN, LIN)	200	300		ns	VIN=0 & VIN=3.3V	
DT	Deadtime Inserted		400		ns	V <sub>IN</sub> =0 & V <sub>IN</sub> =3.3V without external deadtime	
Eon	Turn-on switching energy loss		32		μJ		
EOFF	Turn-off switching energy loss		6		μJ	V <sub>+</sub> =320V, I <sub>D</sub> =0.5A, L=40mH, T <sub>C</sub> =25°C (Note 4)	
Erec	Recovery energy loss		5		μJ		
E <sub>ON,150</sub>	Turn-on switching energy loss		59		μJ		
EOFF,150	Turn-off switching energy loss		7		μJ	V <sub>+</sub> =320V, I <sub>D</sub> =0.5A, L=40mH, T <sub>C</sub> =150°C (Note 4)	
Erec,150	Recovery energy loss		12		μJ		

Note 4: Characterized, not tested at manufacturing

#### **Thermal and Mechanical Characteristics**

Symbol	Description	Min	Тур	Max	Units	Conditions
Rth(J-C)	Junction to Case Thermal Resistance		6.8		°C/W	High Side V-Phase Mosfet (Note 5)

Note 5: Characterized, not tested at manufacturing. Case temperature (T<sub>c</sub>) point shown in Figure 2.

#### Internal NTC – Thermistor Characteristics (IRSM505-055 Only)

Symbol	Description	Min	Тур	Max	Units	Conditions
R <sub>25</sub>	Resistance		47		kΩ	Tc=25°C, ±5% tolerance
R <sub>125</sub>	Resistance		1.41		kΩ	T <sub>C</sub> =125°C
В	B-constant (25-50°C)		4050		К	±2% tolerance (Note 6)
Temperatu	ire Range	-40		125	°C	

Note 6: See application notes for usage



### **Qualification Information**†

Qualification Level		Industrial <sup>††</sup>
Moisture S	ensitivity Level	MSL3 <sup>†††</sup>
RoHS Com	pliant	Yes
UL Certifie	d	Yes – File Number E252584
Machine Model		Class B
ESD	Human Body Model	Class 2

† Qualification standards can be found at International Rectifier's web site <u>http://www.infineon.com/</u>

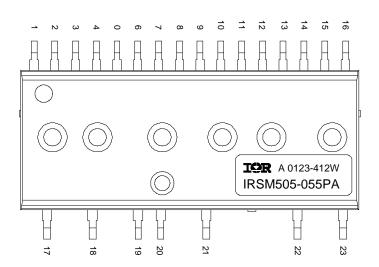
++ Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

+++ SOP23 package only. Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.



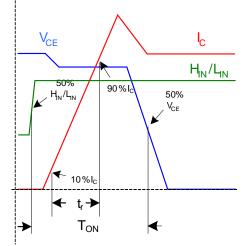
#### **Module Pin-Out Description**

Pin	Name	Description
1	COM	Logic Ground
2	V <sub>B1</sub>	High Side Floating Supply Voltage 1
3	V <sub>CC1</sub>	15V Supply 1
4	HIN1	Logic Input for High Side Gate Driver - Phase 1
5	LIN1	Logic Input for Low Side Gate Driver - Phase 1
6	NC	Not Connected
7	V <sub>B2</sub>	High Side Floating Supply Voltage 2
8	V <sub>CC2</sub>	15V Supply 2
9	HIN2	Logic Input for High Side Gate Driver - Phase 2
10	LIN2	Logic Input for Low Side Gate Driver - Phase 2
11	V <sub>TH</sub>	Thermistor Output (IRSM505-055DA)
	NC	Not Connected (IRSM515-055DA)
12	V <sub>B3</sub>	High Side Floating Supply Voltage 3
13	V <sub>CC3</sub>	15V Supply 3
14	HIN3	Logic Input for High Side Gate Driver - Phase 3
15	LIN3	Logic Input for Low Side Gate Driver - Phase 3
16	NC	Not Connected
17	V+	DC Bus Voltage Positive
18	U/V <sub>S1</sub>	Output - Phase 1, High Side Floating Supply Offset 1
19	V <sub>R1</sub>	Phase 1 Low Side Source
20	V <sub>R2</sub>	Phase 2 Low Side Source
21	V/V <sub>S2</sub>	Output - Phase 2, High Side Floating Supply Offset 2
22	V <sub>R3</sub>	Phase 3 Low Side Source
23	W/V <sub>S3</sub>	Output - Phase 3, High Side Floating Supply Offset 2





#### **Referenced Figures**



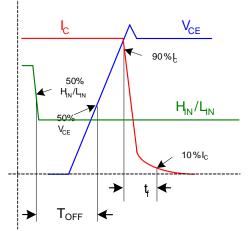


Figure 1a: Input to Output propagation turn-on delay time.

**Figure 1b:** Input to Output propagation turn-off delay time.

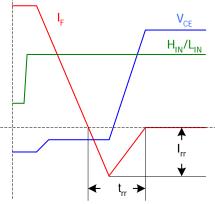
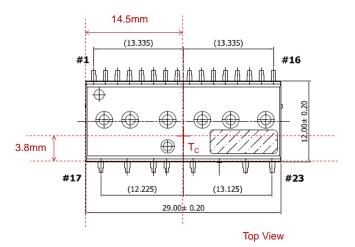
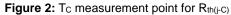


Figure 1c: Diode Reverse Recovery.









#### **Application Notes**

A basic application schematic is shown below.

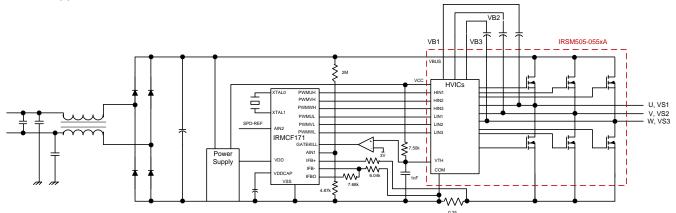


Figure 3: Basic sensor-less motor drive circuit connection. Motor is connected to U, V, W

A complete reference design board for running any permanent magnet motor via sensorless sinusoidal control is available. The board – photo below – features the µIPM<sup>™</sup>-DIP module and the iMotion<sup>™</sup> digital control IC. "Reference design kits are available on <u>www.infineon.com/ipm</u> website"

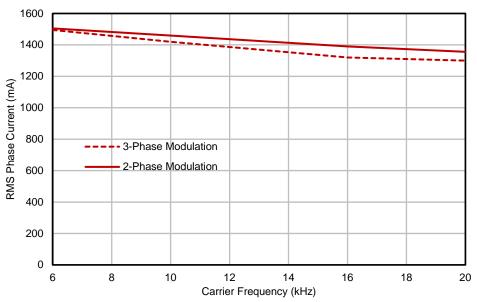


Figure 4: Reference design board featuring the µIPM<sup>™</sup>-DIP module and the iMotion<sup>™</sup> IRMCF171 digital control IC

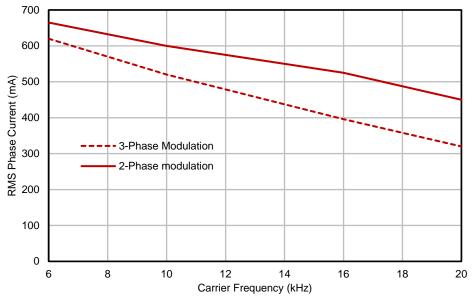


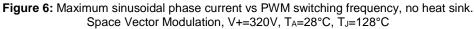
### IRSM505-055 IRSM515-055 Series

Figures 5-7 show the typical current capability for this module at specified conditions. In all tests, the application board – the IRMCS1071-1-D reference board – was placed in a box to prevent cooling from ambient airflow. Figure 5 is derived from using a heat sink that maintains  $T_c$  at 125°C. Figures 6-7 represent current capability for the module as used without any heat sink.  $\Delta T_{JA}$  represents the difference in temperature between the junction of the high-side V-phase Mosfet and the ambient, measured 10cm above and 6cm away from the board. Ambient temperature kept within 28-29°C.

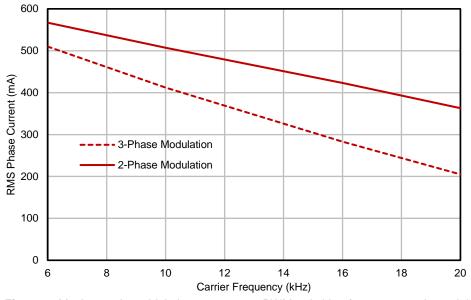


**Figure 5:** Maximum sinusoidal phase current vs PWM switching frequency with a heat sink. Space Vector Modulation, V+=320V, T<sub>A</sub>=28°C, T<sub>J</sub>=150°C, T<sub>C</sub>=125°C









**Figure 7:** Maximum sinusoidal phase current vs PWM switching frequency, no heat sink. Space Vector Modulation, V+=320V, T<sub>A</sub>=28°C, T<sub>J</sub>=98°C

The module contains an NTC – connected between COM and the  $V_{TH}$  pin – which can be used to monitor the temperature of the module. The NTC is effectively a resistor whose value decreases as the temperature rises. The NTC resistance can be calculated at any temperature as follows:

$$R_{TH} = R_{25} e^{\left[B\left(\frac{1}{T_{TH}} - \frac{1}{T_{25}}\right)\right]}$$
, where  $R_{25}$  is 47k $\Omega$  and  $B$  is 4050K

An external resistor network is connected to the NTC, the simplest of which is one resistor pulled up to V<sub>CC</sub> as shown in Figure 3. The V<sub>TH</sub> vs NTC temperature, T<sub>TH</sub> curve for this configuration is shown in Figure 8 below. The min, typical and max curves result from the NTC having a ±5% tolerance on its resistance and ±2% tolerance on the B-parameter.

Figure 9 shows the thermistor temperature,  $T_{TH}$  plotted against the high-side V-phase junction temperature,  $T_J$  for a module without a heat sink. It is thus advisable to shut down the module when  $T_{TH}$  reaches 125°C.



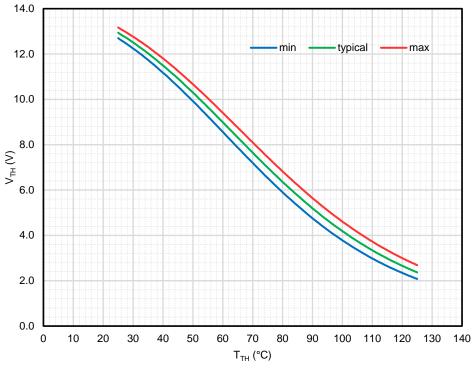
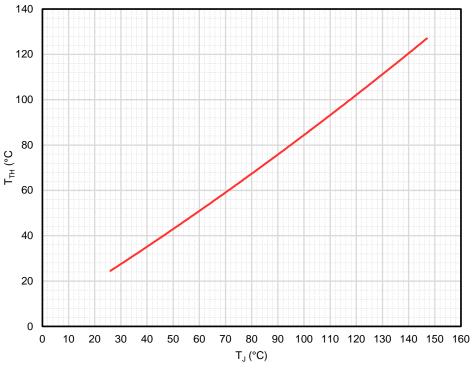
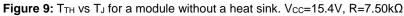


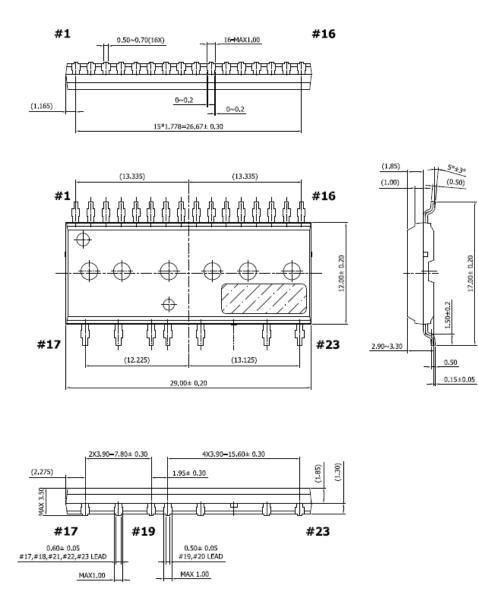
Figure 8: V<sub>TH</sub> vs T<sub>TH</sub> with V<sub>TH</sub> pin pulled up to V<sub>CC</sub> with a 7.50k $\Omega$  (1%, 100ppm) resistor. A 15V, 1% variation in V<sub>CC</sub> is assumed.







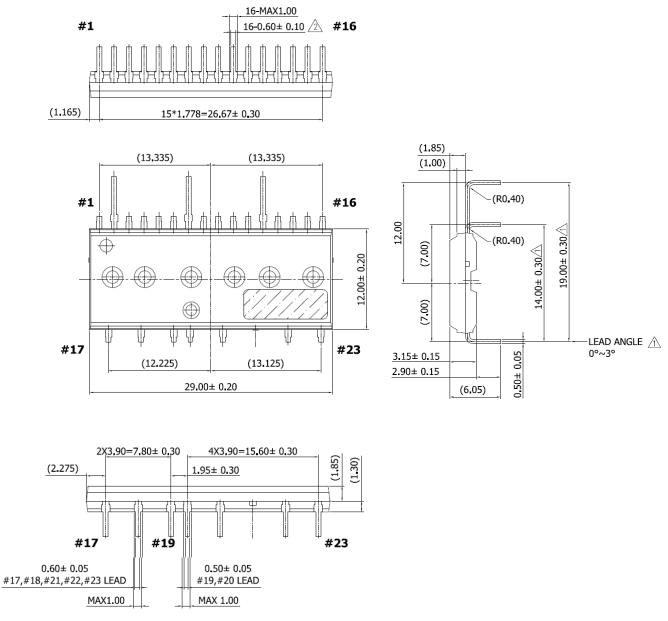
#### **SOP23 Package Outline**



Dimensions in mm



#### **DIP23A Package Outline**



Dimensions in mm



3

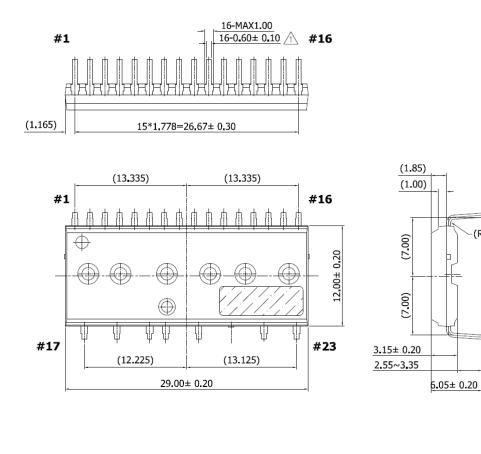
6

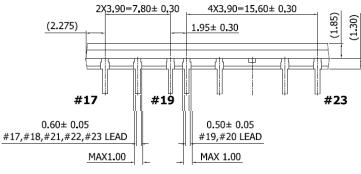
(R0.40)

0.50± 0.05

 $14.55\pm 0.30$ 

#### **DIP23 Package Outline**

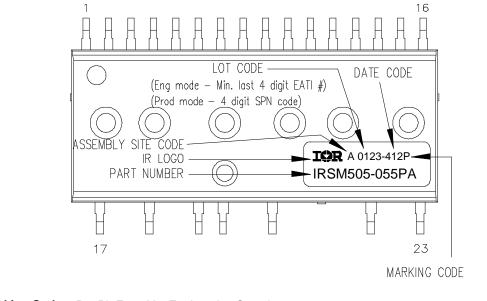




Dimensions in mm



### **Top Marking**



#### Marking Code P = Pb Free; Y = Engineering Samples

**Date Code** YWW format, where Y = least significant digit of the production year, WW = two digits representing

the week of the production year

**Revision History :** 

- Nov 2014 Corrected logic in Figure 1. Added UL certification note.
- Jan 2020 Updated the part table on page 1. OPNs are no longer listed in the datasheet. Updated headers, footers and disclaimers on datasheet.



**Trademarks** All referenced product or service names and trademarks are the property of their respective owners.

Edition 2019-08-09 Published by Infineon Technologies AG 81726 Munich, Germany

© 2019 Infineon Technologies AG. All Rights Reserved.

Do you have a question about this document?

Email: erratum@infineon.com

#### **IMPORTANT NOTICE**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application. For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

#### WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:

IRSM515-055PA IRSM515-055DA2 IRSM505-055PA IRSM505-055DA IRSM505-055DA2 IRSM515-055DA2 IRSM515-055DA2 IRSM515-055DA2AKMA1